Appl. No. 09/938,187 Amdt. Dated May 5, 2004 Reply to Office Action of March 5, 2004

IN THE DRAWINGS

Please accept the following set of replacement drawings.



AND METHOD

Applicant: Biskeborn Serial No. 09/938,187

Sheet 1 of 12

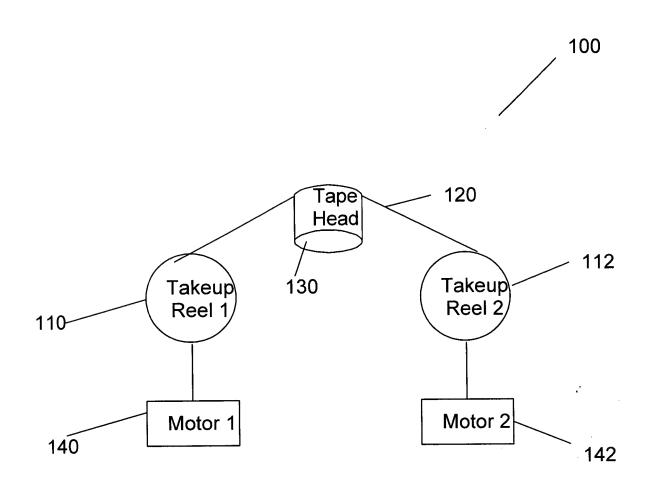


Fig. 1

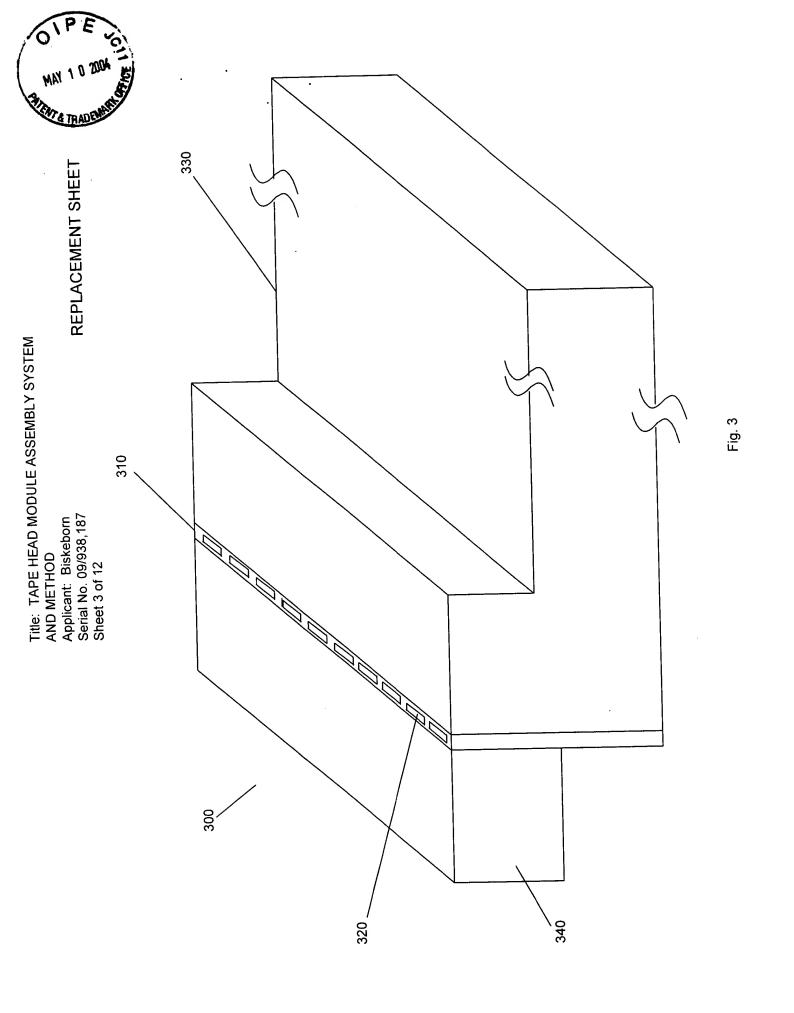


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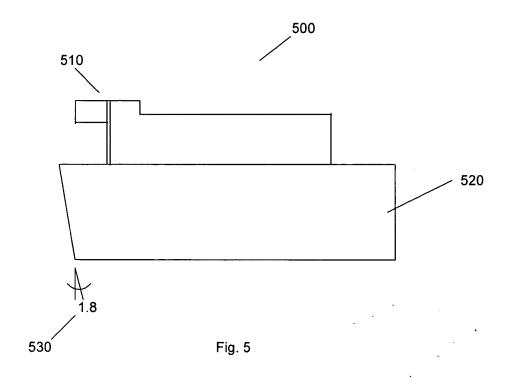
· Sheet 2 of 12

P2			
MR		S2/P1 S1	
	Fig. 2A		
	S2 S1	P2 -	

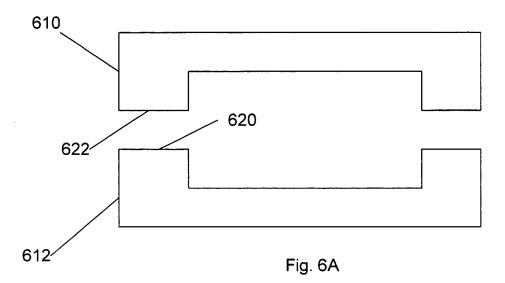




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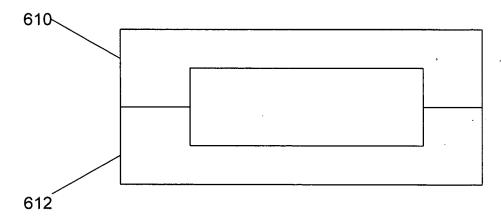


Fig. 6B



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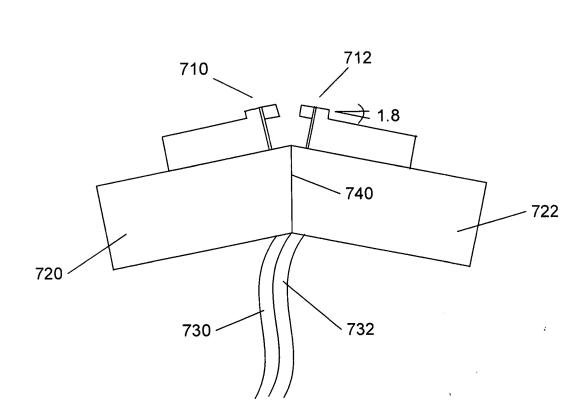


Fig. 7



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REPLACEMENT SHEET

800

Start 810 Wafer Processed Thin Film Tape Heads Are Fabricated And Bonded To The Top Surfaces Of The U-Beams 820 Cables Are Electrically Attached To The Heads And Bonded To The U-Beams For Strain Relief In The Region Between The Legs 830 The Cabled Beams Are Then Positioned With The End Surfaces Of The Legs Of One In Close Proximity To Those Of Its Companion 840 Critical Height, Wrap Angle And Track-To-Track Alignments Are Performed 850 The Beams Are Bonded Together Using An Adhesive In The Narrow Gap Between The Ends Of The Legs End

Fig. 8

Fig. 9

REPLACEMENT SHEET

Title: TAPE HEAD MODULE ASSEMBLY SYSTEM AND METHOD Applicant: Biskeborn Serial No. 09/938,187 Sheet 10 of 12

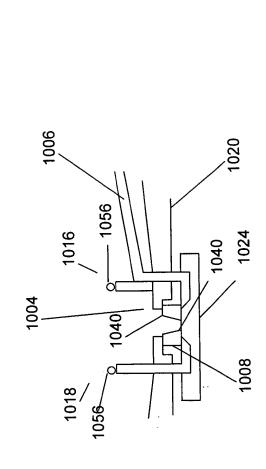


Fig. 10c

Fig. 10b



1100

Title: TAPE HEAD MODULE ASSEMBLY SYSTEM

AND METHOD
Applicant: Biskeborn
Serial No. 09/938,187

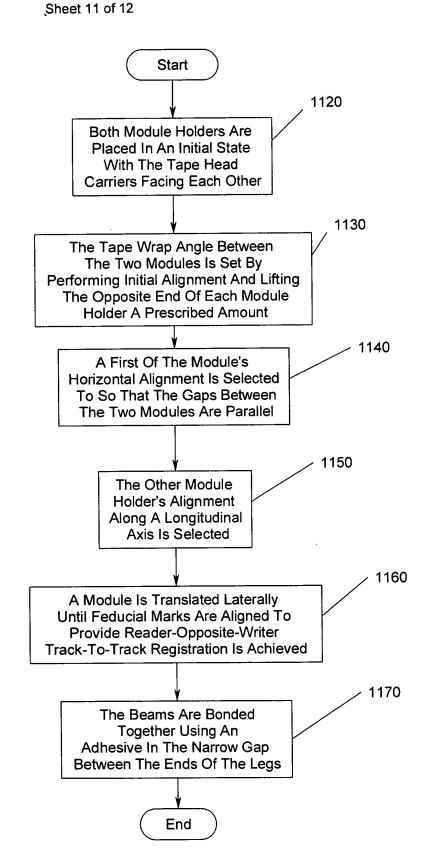


Fig. 11



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REPLACEMENT SHEET

Optical Fringe Measurements
Between The Modules And
The Hard Transparent
Surface Are Used To Adjust For
Minimum Fringe Interference Patterns
Thereby Achieving Optimal
Alignment Of The Modules

Fig. 12